

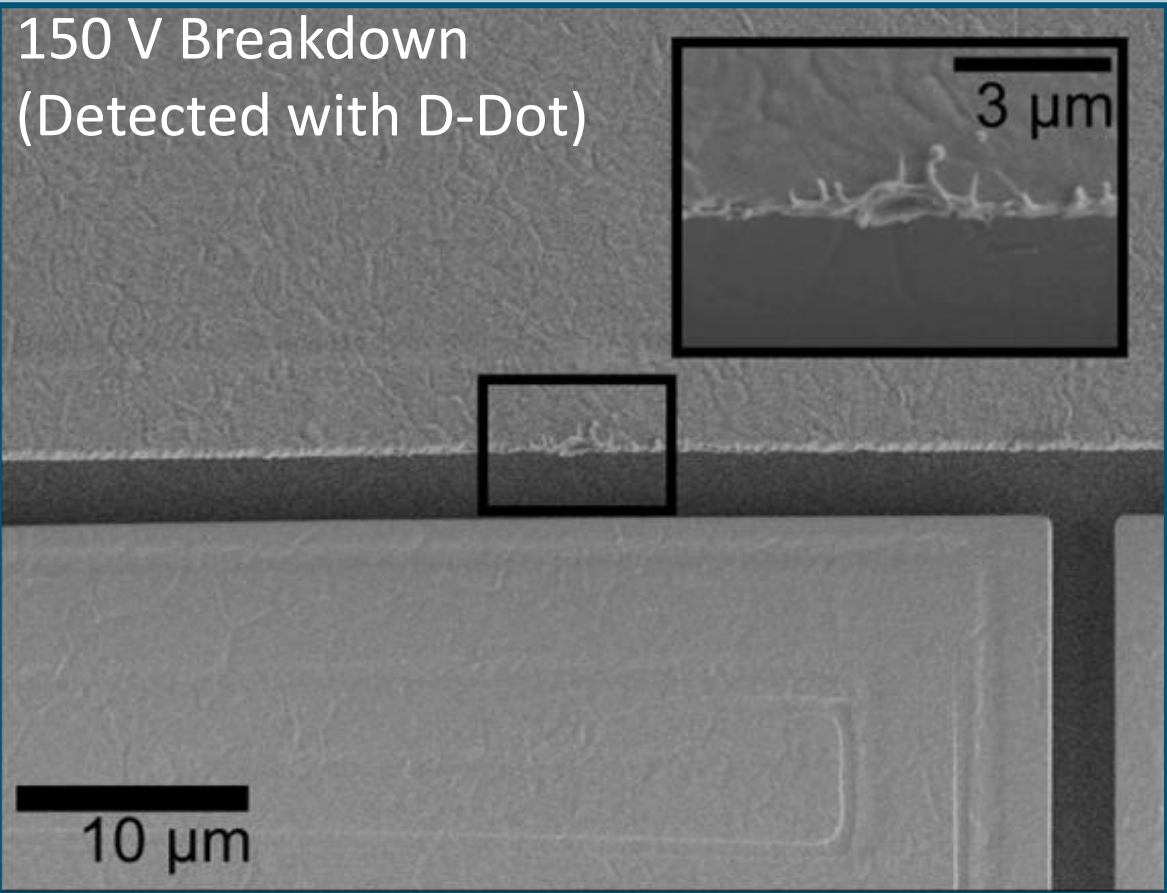
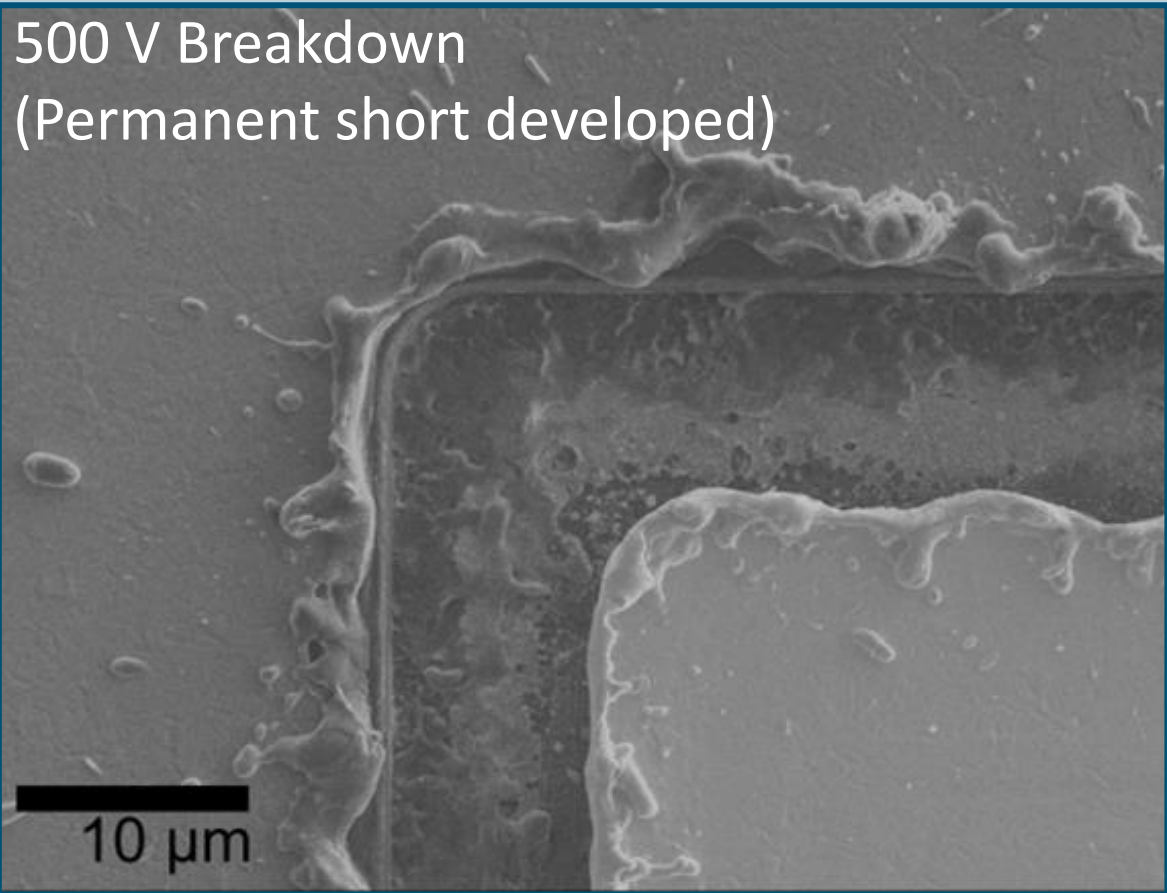


Detecting and Minimizing RF Breakdown on Microfabricated Surface Ion Traps

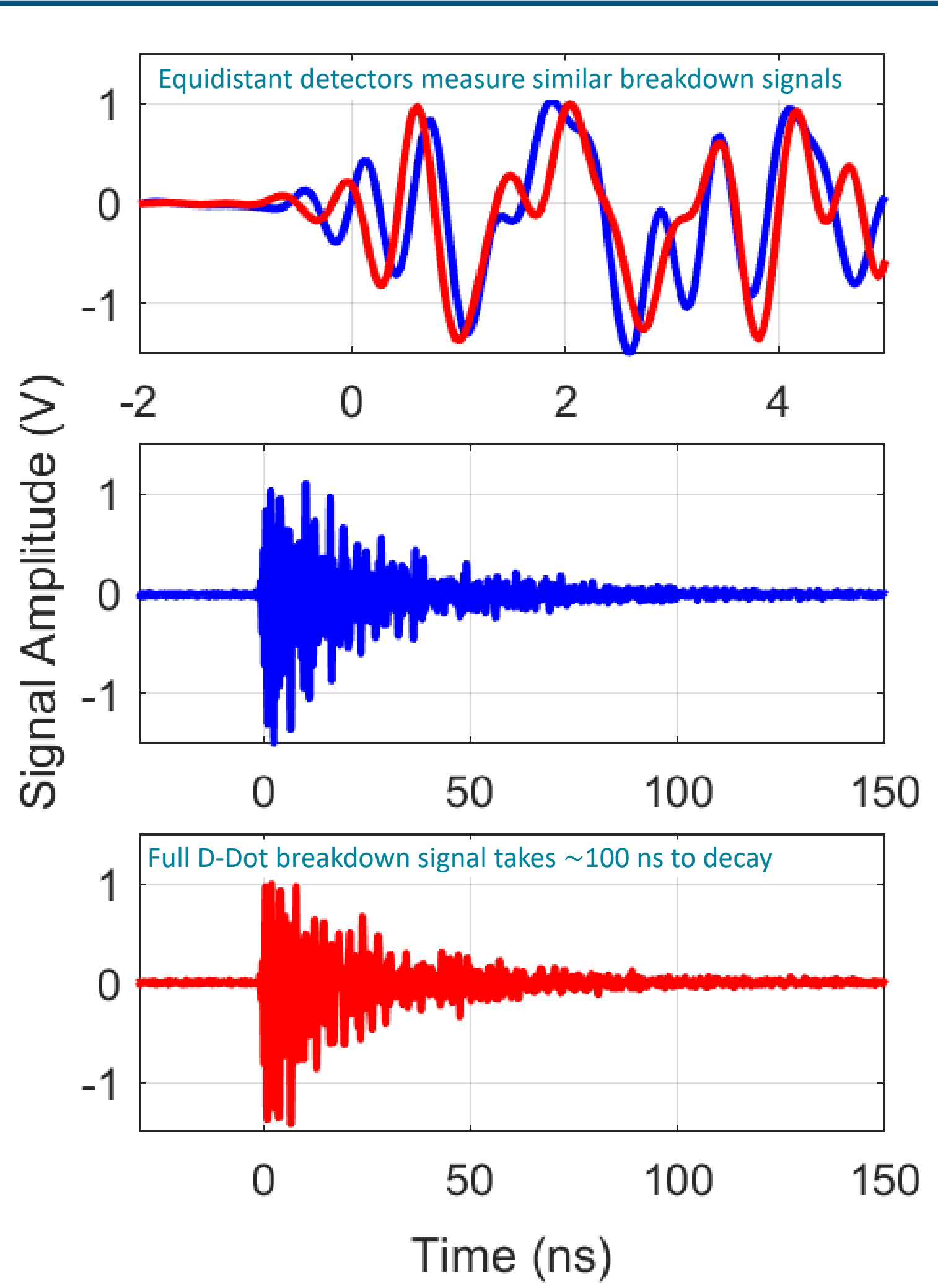
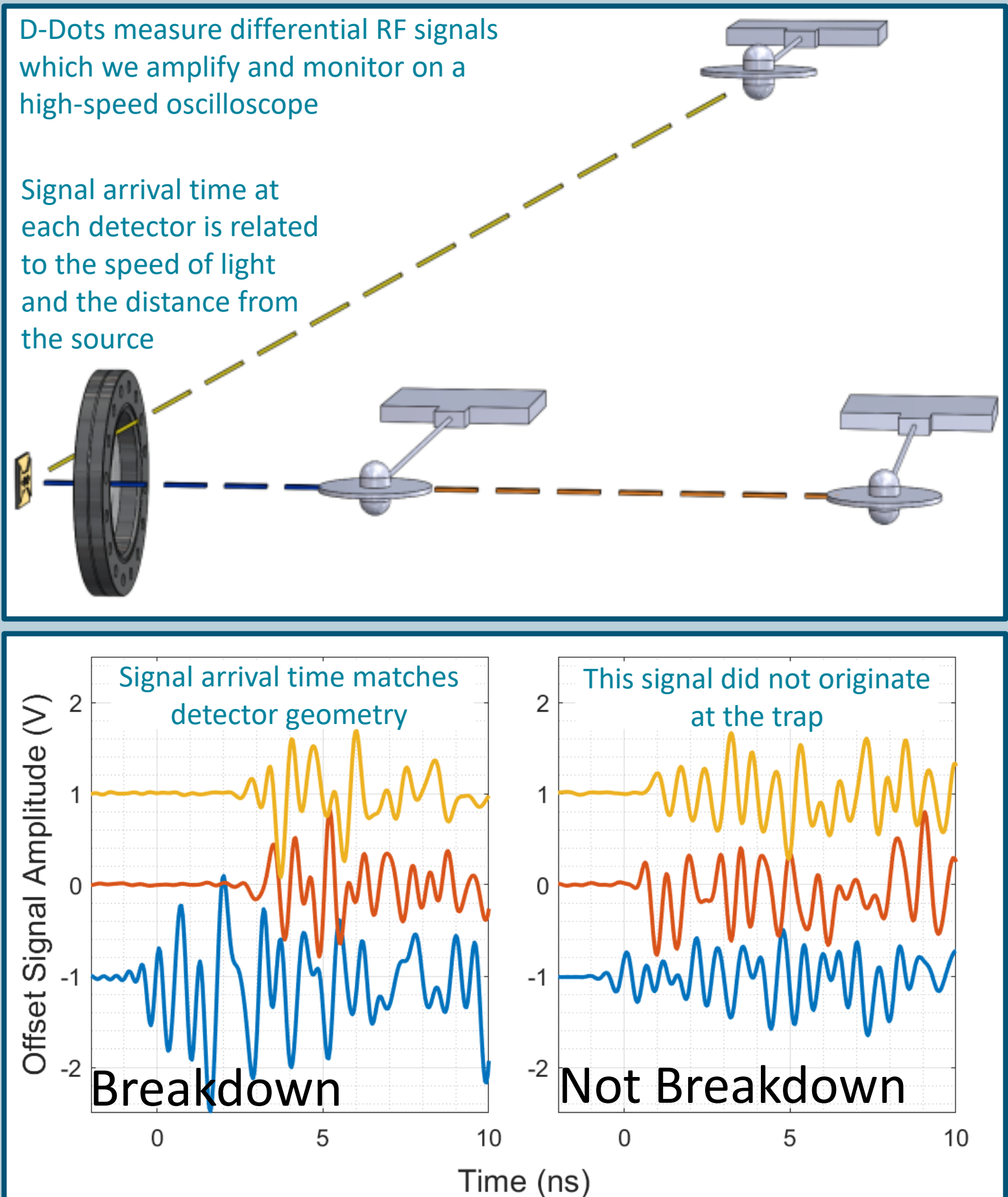
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Background

- **Successful ion traps need to sustain high voltage without breakdown**
- Currently impossible to calculate safe operating voltages *a priori*
 - Fabrication uncertainties
 - Unknown physics
- Breakdown causes problems including:
 - No effect
 - Trap instability
 - Total device failure (permanent short)
- Trap failure can take hours or days to occur
 - Often no warning
- We developed two techniques for *in situ* breakdown detection
 - D-Dot detection
 - Back-reflection detection
- Allows detection of small breakdown events
 - Any breakdown can herald catastrophic breakdown
- Techniques employed to characterize breakdown on Sandia devices
- **Best practices developed for safe device operation**



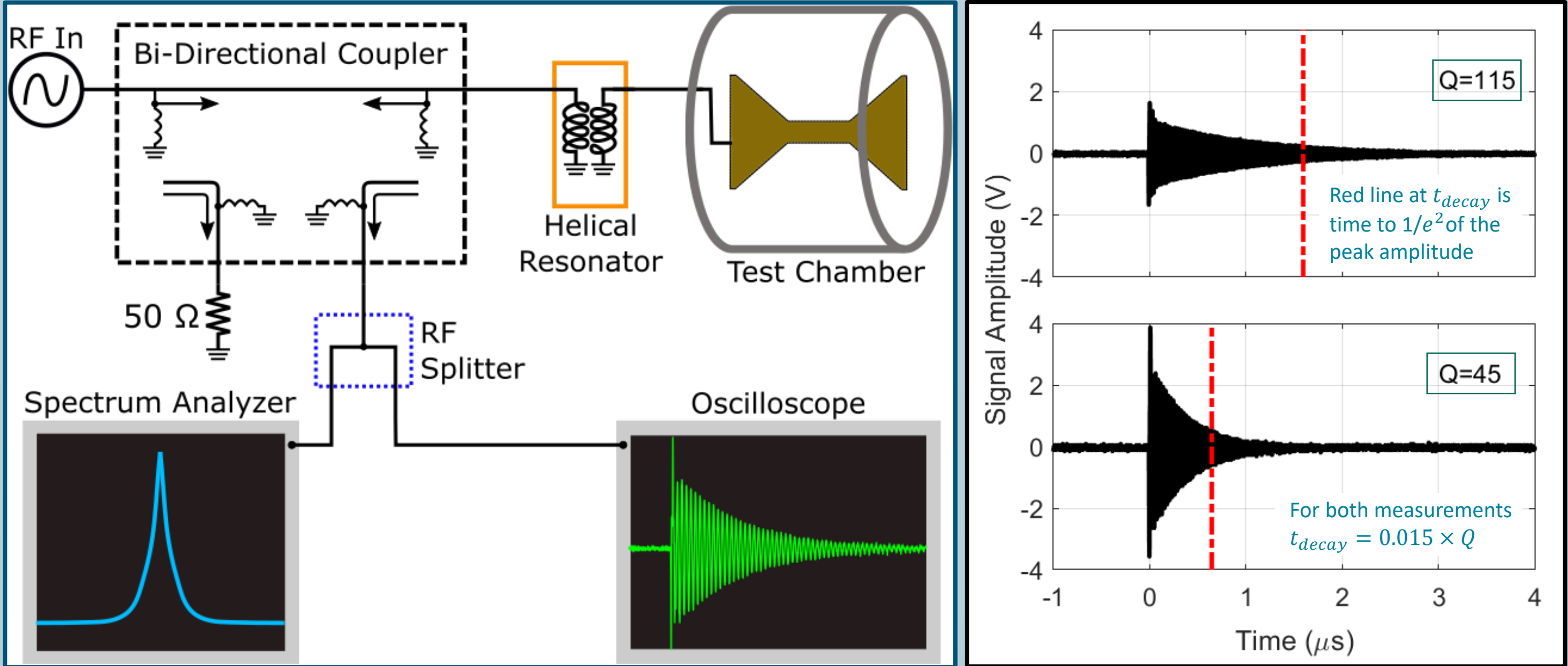
D-Dot Detection



Conclusions and Recommendations

- Breakdown on any device could be catastrophic and should be avoided
- If breakdown does happen, low voltage is better and is often not fatal to the device
- Turn voltage up *slowly* and monitor for breakdown
 - Especially important with new devices
- If a single breakdown event occurs, reduce voltage and wait
 - Voltage increase may be safe later
- Monitoring less critical after several weeks of use

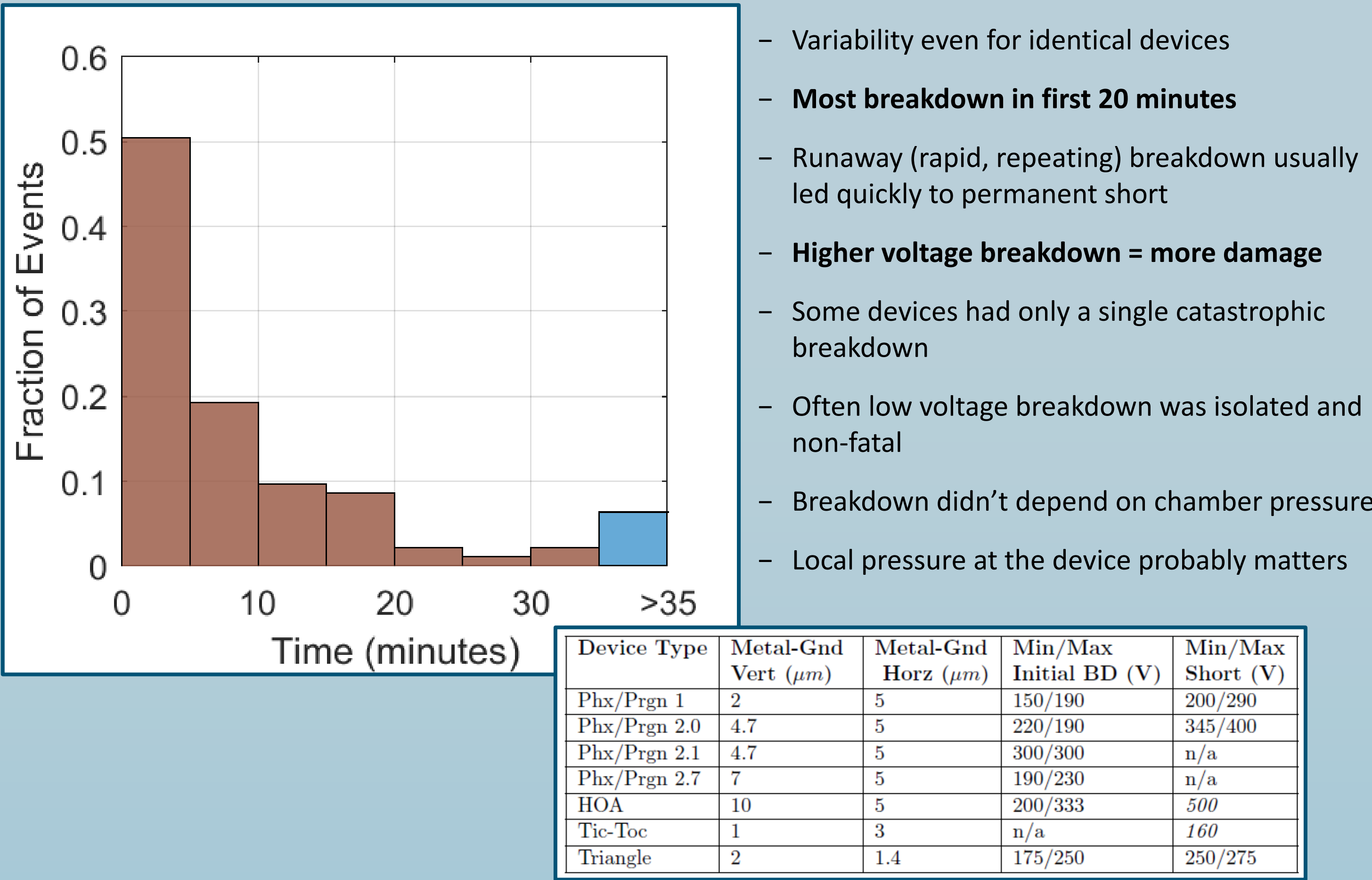
Back Reflection Detection



Experiment

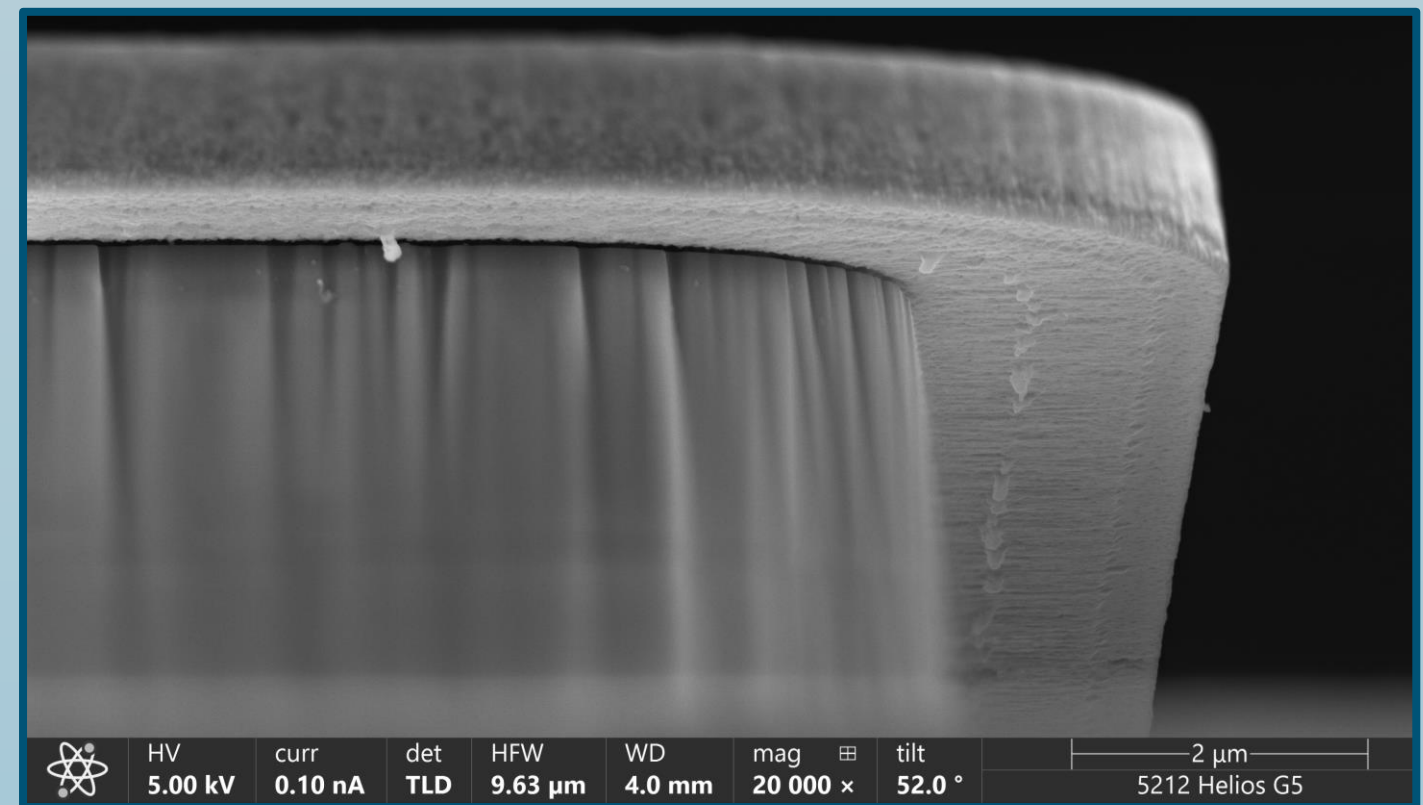
- Multiple devices were tested for breakdown, vacuum pressures ranged from low 10^{-7} to high 10^{-10} mbar.
- Voltages were ramped slowly, and held for about 40 minutes at each value (sometimes much longer).
- Ramping continued until rapid, runaway breakdown, or the development of a permanent short.
- If pressure increased above 9×10^{-7} during ramp, voltage was reduced until the vacuum recovered.
- All measurements were done with D-Dots, but the last few device tests also used back-reflection monitoring.

Results



Future Plans

- Future devices will be monitored for breakdown
- Breakdown experiments with various dedicated test structures are in development
- Fabrication and post processing procedures are being developed to mitigate the formation of asperities (see below)
 - Probable that most breakdown events occur at or near such asperities



Wilson, J. M., Tilles, J. N., Haltli, R. A., Ou, E., Blain, M. G., Clark, S. M., & Revelle, M. C. (2022). *In situ detection of RF breakdown on microfabricated surface ion traps*. *Journal of Applied Physics*, 131(13), 134401. doi: 10.1063/5.0082740

